勝 特 力 材 料 886-3-5753170 胜特力电子(上海) 86-21-54151736 胜特力电子(深圳) 86-755-83298787 Http://www.100y.com.tw

Order this document by MR750/D

Designer's™ Data Sheet

High Current Lead Mounted Rectifiers

- Current Capacity Comparable to Chassis Mounted Rectifiers
- Very High Surge Capacity
- Insulated Case

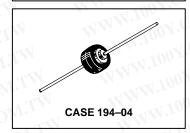
Mechanical Characteristics:

- Case: Epoxy, Molded
- · Weight: 2.5 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Lead is Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- · Polarity: Cathode Polarity Band
- Shipped 1000 units per plastic bag. Available Tape and Reeled, 800 units per reel by adding a "RL" suffix to the part number
- Marking: R750, R751, R752, R754, R758, R760

MR750 MR751 MR752 MR754 MR756 MR758 MR760

MR754 and MR760 are Motorola Preferred Devices

HIGH CURRENT LEAD MOUNTED SILICON RECTIFIERS 50–1000 VOLTS DIFFUSED JUNCTION



MAXIMUM RATINGS

Characteristic	Symbol	MR750	MR751	MR752	MR754	MR756	MR758	MR760	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	VRRM VRWM VR	50	100	200	400	600	800	1000 -	Volts
Non–Repetitive Peak Reverse Voltage (Halfwave, single phase, 60 Hz peak)	VRSM	60	120	240	480	720	960	1200	Volts
RMS Reverse Voltage	VR(RMS)	35	70	140	280	420	560	700	Volts
Average Rectified Forward Current (Single phase, resistive load, 60 Hz) See Figures 5 and 6	1000	COM		$2 (T_L = 60)$ $(T_A = 60)$				TW	Amps
Non–Repetitive Peak Surge Current (Surge applied at rated load conditions)	I _{FSM}	ON.CO	M.T.V	40	0 (for 1 cy	cle)	V.CO	ATW	Amps
Operating and Storage Junction Temperature Range	T _J , T _{stg}	OUX.C	OMIT		-65 to +17	75	not.CC	$\overline{M_{1,1}}$	°C

ELECTRICAL CHARACTERISTICS

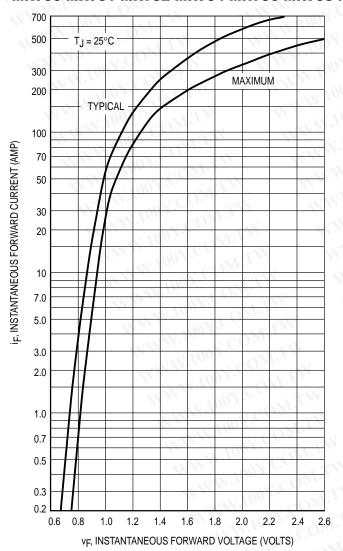
Char	acteristic and Con	ditions	Symbol	Max	Unit
Maximum Instantaneous Forward (i _F = 100 Amps, T _J = 25°C)	d Voltage Drop	NWW.100Y.COM.TW	٧F	1.25	Volts
Maximum Forward Voltage Drop (I _F = 6.0 Amps, T _A = 25°C, 3/8	" leads)	WWW.100X.COW.TW	VF	0.90	Volts
Maximum Reverse Current (Rated dc Voltage)	T _J = 25°C T _J = 100°C	MMN.100	l _R	25 1.0	μA mA

Designer's Data for "Worst Case" Conditions — The Designer's Data Sheet permits the design of most circuits entirely from the information presented. SOA Limit curves — representing boundaries on device characteristics — are given to facilitate "worst case" design.

Preferred devices are Motorola recommended choices for future use and best overall value.

Rev 2





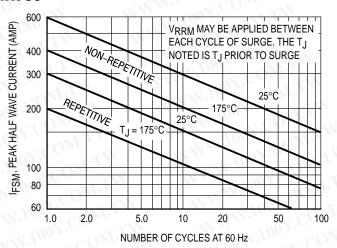


Figure 2. Maximum Surge Capability

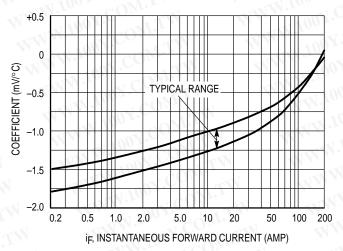


Figure 1. Forward Voltage

Figure 3. Forward Voltage Temperature Coefficient

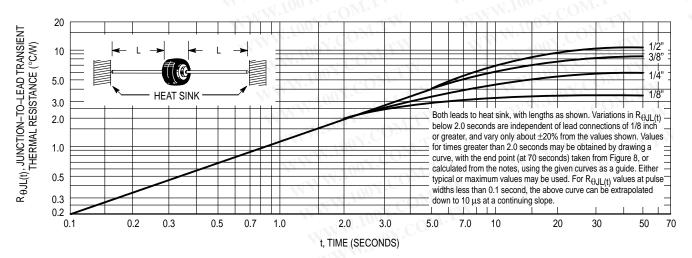


Figure 4. Typical Transient Thermal Resistance

勝 特 力 材 料 886-3-5753170 胜特力电子(上海) 86-21-54151736 胜特力电子(深圳) 86-755-83298787 Http://www.100y.com.tw

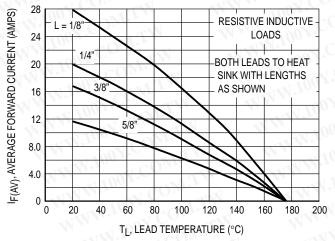


Figure 5. Maximum Current Ratings

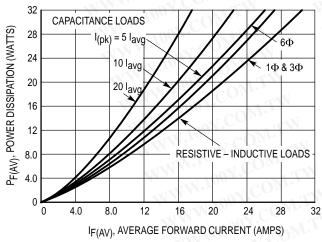


Figure 7. Power Dissipation

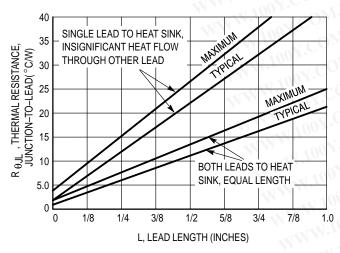


Figure 8. Steady State Thermal Resistance

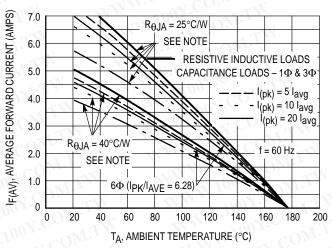
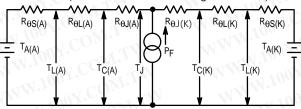


Figure 6. Maximum Current Ratings

NOTES THERMAL CIRCUIT MODEL (For Heat Conduction Through The Leads)



Use of the above model permits junction to lead thermal resistance for any mounting configuration to be found. Lowest values occur when one side of the rectifier is brought as close as possible to the heat sink as shown below. Terms in the model signify:

T_A = Ambient Temperature T_I = Lead Temperature T_C = Case Temperature T_J = Junction Temperature

 $R_{\Theta S}^{-}$ = Thermal Resistance, Heat Sink to Ambient $R_{\Theta L}$ = Thermal Resistance, Lead to Heat Sink

 $R_{\theta J}^{-}$ = Thermal Resistance, Junction to Case

PF = Power Dissipation

(Subscripts A and K refer to anode and cathode sides, respectively.)

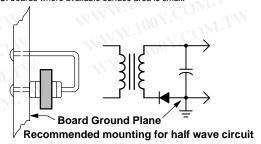
Values for thermal resistance components are:

 $R_{\theta L} = 40^{\circ}$ C/W/in. Typically and 44° C/W/in Maximum.

 $R_{\Theta} \overline{J} = 2^{\circ}C/W$ typically and $4^{\circ}C/W$ Maximum.

Since $R_{\theta,J}$ is so low, measurements of the case temperature, T_C , will be approximately equal to junction temperature in practical lead mounted applications. When used as a 60 Hz rectifierm the slow thermal response holds $T_{J(PK)}$ close to $T_{J(AVG)}$. Therefore maximum lead temperature may be found from: $T_L = 175^\circ - R_{\theta,J_L}$ PF. PF may be found from Figure 7.

The recommended method of mounting to a P.C. board is shown on the sketch, where $R_{\Theta,JA}$ is approximately 25°C/W for a 1–1/2" x 1–1/2" copper surface area. Values of 40°C/W are typical for mounting to terminal strips or P.C. boards where available surface area is small.



勝 特 力 材 料 886-3-5753170 胜特力电子(上海) 86-21-54151736 胜特力电子(深圳) 86-755-83298787 Http://www.100y.com.tw

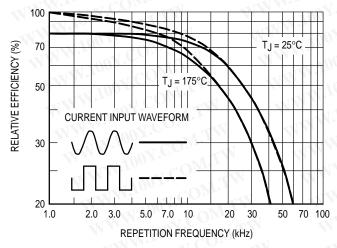


Figure 9. Rectification Efficiency

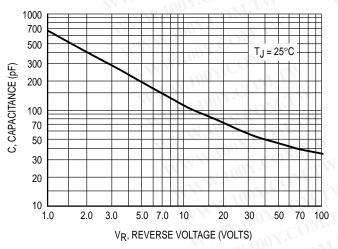


Figure 11. Junction Capacitance

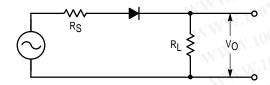


Figure 13. Single-Phase Half-Wave Rectifier Circuit

The rectification efficiency factor σ shown in Figure 9 was calculated using the formula:

$$\sigma = \frac{P_{(dc)}}{P_{(rms)}} = \frac{\frac{V_{20}(dc)}{R_L}}{\frac{V_{20}(rms)}{R_L}} \cdot 100\% = \frac{V_{20}(dc)}{V_{20}(ac) + V_{20}(dc)} \cdot 100\%$$

For a sine wave input V_{m} sin (wt) to the diode, assumed lossless, the maximum theoretical efficiency factor becomes:

$$\sigma_{\text{(sine)}} = \frac{\frac{V^2 m}{\pi^2 R_L}}{\frac{V^2 m}{4 R_L}} \cdot 100\% = \frac{4}{\pi^2} \cdot 100\% = 40.6\%$$
 (2)

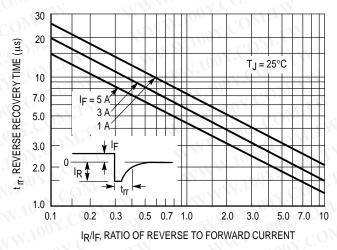


Figure 10. Reverse Recovery Time

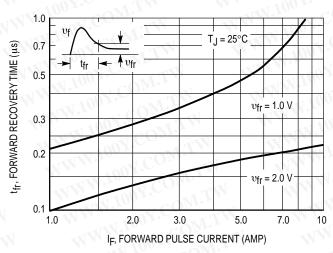


Figure 12. Forward Recovery Time

For a square wave input of amplitude V_m, the efficiency factor becomes:

$$\sigma_{\text{(square)}} = \frac{\frac{V^{2}m}{^{2}RL}}{\frac{V^{2}m}{RL}} \cdot 100\% = 50\%$$
 (3)

(A full wave circuit has twice these efficiencies)

As the frequency of the input signal is increased, the reverse recovery time of the diode (Figure 10) becomes significant, resulting in an increasing ac voltage component across R_L which is opposite in polarity to the forward current, thereby reducing the value of the efficiency factor σ , as shown on Figure 9.

It should be emphasized that Figure 9 shows waveform efficiency only; it does not provide a measure of diode losses. Data was obtained by measuring the ac component of $V_{\rm O}$ with a true rms ac voltmeter and the dc component with a dc voltmeter. The data was used in Equation 1 to obtain points for Figure 9.

勝 特 力 材 料 886-3-5753170 胜特力电子(上海) 86-21-54151736 胜特力电子(深圳) 86-755-83298787

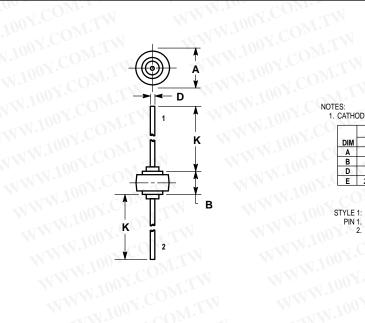
WWW.100Y.C

OM.TW

WWW.100Y.COM.TW

WWW.100Y.COM.

PACKAGE DIMENSIONS



WWW.100Y.COM.TW

WWW.100

WWW.100Y.CO.M.

WWW.100Y.C

WW.100Y.COM.TW

WWW.100Y.CONE

COM.TW

	MILLIN	METERS	INC	HES
DIM	MIN	MAX	MIN	MAX
Α	8.43	8.69	0.332	0.342
В	5.94	6.25	0.234	0.246
D	1.27	1.35	0.050	0.053
E	25.15	25.65	0.990	1.010

STYLE 1: pin 4 PIN 1. CATHODE 2. ANODE WWW.100Y

WWW.100Y.COL

W.100Y.COM.TW CASE 194-04 **ISSUE F**

特力材料886-3-5753170 胜特力电子(上海) 86-21-54151736 胜特力电子(深圳) 86-755-83298787 WWW.100Y.COM.TW

Http://www.100y.com.tw WWW.100Y.COM.TW

Rectifier Device Data 5